

January 2011

Dear Tyco Electronics Customer:

In response to your inquiry regarding Tyco Electronics' activities relative to **<u>REACH</u>**, the European Union Regulation concerning the <u>Registration</u>, <u>Evaluation</u>, and <u>Authorisation of <u>Chemicals</u></u>, please be advised of the following:

Awareness and focus

Tyco Electronics is fully aware of the European REACH regulation and has dedicated programs and resources to deal with all legislative requirements and business continuity concerns related to REACH.

Registration of Substances

Although Tyco Electronics is principally a supplier of articles which do not require registration, we have completed the process of contacting our suppliers of "substances, preparations, and articles" to ensure that all necessary preregistration/registration requirements are being complied with in the required timescales. This effort extends to all materials used by Tyco Electronics that are within the scope of REACH and with regard to the applications in which the materials are used in our products. Tyco Electronics is engaged in the registration process for those few substances where we are either manufacturer or importer.

Ongoing supply of our products

As a result of the above mentioned efforts, we expect that REACH will not interfere with the supply of materials used in Tyco Electronics' products and that there will be no interruption in the supply of Tyco Electronics' products to our customers.

Substances of Very High Concern (SVHCs)

In **October 2008** the European Chemical Agency (ECHA) published a first list of 15 substances that are under consideration for inclusion in Annex XIV as Substances of Very High Concern. We have essentially completed the assessment of our products against this list and have found that the vast majority do not contain any of these SVHCs. We have added this October 2008 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **January 2010**, ECHA has published a second list of 14 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. In **March 2010**, a single additional substance was added. We have largely completed our assessment of these15 substances with no products identified as containing any of these substances to date. We have added this Jan/Mar 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **June 2010**, ECHA published a list of 8 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. Our initial assessment indicates that these substances are not contained in any TE products. We have added this June 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **December 2010**, ECHA published a list of 8 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. Our initial assessment indicates that these substances are not contained in any TE products. We have added this December 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

Be assured that, if any Substance of Very High Concern is identified in any of our products above the threshold of 0.1% by weight, Tyco Electronics will take necessary actions to make the required **notification** to our customers.



Annex XVII Restrictions

In June 2009 ECHA amended Annex XVII of REACH, consolidating a number of existing restrictions that had been implemented as amendments to Directive 76/769/EEC. Tyco Electronics was in compliance with these regulations previously and we remain compliant to the current Annex XVII restrictions. (Note that in many cases these restrictions are application specific and our statement of compliance is based on our understanding that our products are not used in these restricted applications.) We will continue to monitor any new additions to Annex XVII and will update our compliance statement as appropriate. Should you require more detailed information regarding use of our products in any restricted applications, please use the website indicated below.

For additional information regarding Tyco Electronics Product Compliance initiatives, please visit our Customer Support Center at www.tycoelectronics.com/customersupport/rohssupport/center .

Should you have any further questions, do not hesitate to contact your Tyco Electronics Sales Engineer.

David R. Bender Director, Product Compliance Tyco Electronics



Requested Part

05 September 2012

183635-3

(Part 1 of 1)

INSERT CAT5E 2x ISDN /B

Status: Active Solder Process Capability Code: China RoHS:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

IRL_

David R. Bender **Director**, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

(50) **Restricted Materials Above Threshold** 有毒有害物质或元素 电子元件 Hazardous Substance (Electronic Component) 183635-3 铅 汞 六价铬 多溴联苯 多溴二苯醚 镉 (Pb) (Hg) (Cd) (Cr6) (PBB) (PBDE) 电子元件 Х 0 0 0 0 0 (Electronic Component) O: 表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard. X: 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 183635-3:

INSERT CAT5E 2x ISDN /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Statement of Compliance

Requested Part

05 September 2012

183636-3

(Part 1 of 1)

INSERT CAT5E 2x 10/100BT /B

Status: Active Solder Process Capability Code:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

China RoHS:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: **REACH December 2011 SvHC Compliance:** REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

I IRL

David R. Bender **Director, Product Compliance**

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
	183636-3	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒々 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒本 Indicates that the ca SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	

Description for part 183636-3:

INSERT CAT5E 2x 10/100BT /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

183641-3

(Part 1 of 1)

INSERT CAT5E 10/100BT & ISDN /B

Status: Active Solder Process Capability Code: China RoHS:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender **Director, Product Compliance**

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 183641-3		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	Х	0	0	0	0	0	
O:	表示该部件内有毒 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of I	
X:	表示该部件内有毒本 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of	

Description for part 183641-3:

INSERT CAT5E 10/100BT & ISDN /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336548-3

(Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /B

Status: Active Solder Process Capability Code:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability China RoHS: China Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
	336548-3	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
О:	表示该部件内有毒存 Indicates that the ca SJ/T 1136 3-2006 s	oncentration of				•	nt threshold of t	
X:	表示该部件内有毒体 Indicates that the ca SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	

Description for part 336548-3:

INSERT CAT6 1x RJ45 T568A /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

284584-3

(Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /B

Status: Active

Solder Process Capability Code:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability China RoHS: Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,						
`	284584-3	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
O:	表示该部件内有毒有 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of th	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				oove the releva	nt threshold of t	

Description for part 284584-3:

INSERT CAT5E 1x RJ45 T568A /B

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Requested Part

05 September 2012

183635-5

(Part 1 of 1)

INSERT CAT5E 2x ISDN /W

Status: Active

Solder Process Capability Code:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability China RoHS: (50) Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender **Director**, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件		有毒有害物质或元素 Hazardous Substance							
(Elect	ronic Component) 183635-5	铅 (Pb)	汞 (Hg)	田aZaruo 領 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
(Elect	电子元件 ronic Component)	х	0	о	0	0	0		
О:	表示该部件内有毒 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th		
X:	表示该部件内有毒 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				oove the releva	nt threshold of th		

Description for part 183635-5:

INSERT CAT5E 2x ISDN /W

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Requested Part

05 September 2012

183636-5

(Part 1 of 1)

INSERT CAT5E	2x 10/100BT /W
Status:	Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: 600 Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
	183636-5	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	x	0	0	0	0	0	
О:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration of			· · · · · ·		nt threshold of t	

Description for part 183636-5:

INSERT CAT5E 2x 10/100BT /W

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Requested Part

05 September 2012

183641-5

(Part 1 of 1)

INSERT CAT5E 10/100BT & ISDN /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: China RoHS:

Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

SPEL-

David R. Bender **Director, Product Compliance**

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance						
	183641-5	铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
	电子元件	х	0	0	0	0	0	
(Elect	tronic Component)							
0:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o		11		oove the releva	nt threshold of t	

Description for part 183641-5:

INSERT CAT5E 10/100BT & ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336480-5

(Part 1 of 1)

ASSY ISO CAT 7 AMP CO INSERT W

Status:	Superseded
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Not reviewed for China RoHS compliance
Exemptions:	Exemption Details Currently Unavailable
REACH Oct 2008 SvHC Compliance:	Not reviewed for REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Not reviewed for REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Not reviewed for REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Not reviewed for REACH June 2012 SvHC(s)
Halogen Content:	Not Yet Reviewed for halogen content

ORL-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336480-5

05 September 2012

1711409-5 INSERT CAT7a AMPTWIST7aS style /W (Equivalent Part 1 of 1)

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	6(c) - Pb-Alloy in Copper
	7(x) - Pb-Used for ELV, 5/6 parts
REACH Oct 2008 SvHC Compliance:	Not reviewed for REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Not reviewed for REACH June 2012 SvHC(s)
Halogen Content:	Not Yet Reviewed for halogen content

New wiring

Description of Difference:

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336548-5

(Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /W

Status: Active EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process

China RoHS:

5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
·	336548-5	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
	电子元件	х	0	0	0	0	О	
(Elect	tronic Component)]				
O:	表示该部件内有毒有 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration o					nt threshold of t	

Description for part 336548-5:

INSERT CAT6 1x RJ45 T568A /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

284584-5

(Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: GB Restricted Materials Above Threshold

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender **Director**, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead. hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

(Elect	电子元件 tronic Component)				害物质或元素 ous Substance		
	284584-5	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
(Elec	电子元件 tronic Component)	Х	0	0	0	0	0
O:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of th
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				ove the releva	nt threshold of t

Description for part 284584-5:

INSERT CAT5E 1x RJ45 T568A /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



Requested Part

05 September 2012

336554-5

(Part 1 of 1)

INSERT CAT6 2x ISDN /W

S	Status:
5	EU RoHS/ELV Code:
Ν	Solder Process Capability Code:
	China RoHS:

Superseded 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.

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RoHS Equivalent Part(s) for Part 336554-5

05 September 2012

1711807-5 INSERT CAT6a 2x ISDN /W

Active

(Equivalent Part 1 of 1)

Status
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability No Restricted Materials Above Threshold

Exemptions:
REACH Oct 2008 SvHC Compliance:
REACH Jan/Mar 2010 SvHC Compliance:
REACH June 2010 SvHC Compliance:
REACH Dec 2010 SvHC Compliance:
REACH June 2011 SvHC Compliance:
REACH December 2011 SvHC Compliance:
REACH June 2012 SvHC Compliance:
Halogen Content:
Description of Difference:

No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

(50)	Restricted Materials Above Threshold
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电子元件 (Electronic Component) 336554-5		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	x	0	0	0	0	0	
O:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration of				•	nt threshold of t	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	

Description for part 336554-5:

INSERT CAT6 2x ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336553-5

(Part 1 of 1)

INSERT CAT6 2x 10/100BT /W

Status: Super EU RoHS/ELV Code: 5 of 6 Solder Process Capability Code: Not ap China RoHS: 600 F

Superseded 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability (5) Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336553-5

05 September 2012

1711801-5 INSERT CAT6a 2x 10/100BT /W

Active

(Equivalent Part 1 of 1)

Status:
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability O Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

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Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance、						
•	336553-5	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration of		•••••••		•	nt threshold of th	
X:	表示该部件内有毒有 Indicates that the ca SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	

Description for part 336553-5:

INSERT CAT6 2x 10/100BT /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336549-5

(Part 1 of 1)

INSERT CAT6 10/100BT & ISDN /W

Status:	Superseded
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336549-5

05 September 2012

1711804-5 INSERT CAT6a 10/100BT & ISDN /W

Active

(Equivalent Part 1 of 1)

Status:
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability O Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance:

REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————					
336549-5	-	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Comp	onent)	x	0	0	0	0	0
Indicates		ncentration o	SJ/T 11363-2 f the hazardou			下 Now the relevar	nt threshold of t
Indicates		ncentration o	出 SJ/T 11363 f the hazardou			oove the relevar	nt threshold of t

Description for part 336549-5:

INSERT CAT6 10/100BT & ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

183635-1

(Part 1 of 1)

INSERT CAT5E 2x ISDN /A

Status: Active

Solder Process Capability Code: China RoHS:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compilance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 183635-1		有毒有害物质或元素 ————————————————————————————————————					
		铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
(Elect	电子元件 ronic Component)	x	0	0	0	0	0
0:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t
X :	表示该部件内有毒有 Indicates that the c SJ/T 1136 3-2006 s	oncentration o					nt threshold of t

Description for part 183635-1:

INSERT CAT5E 2x ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

183636-1

(Part 1 of 1)

INSERT CAT5E 2x 10/100BT /A

 Status:
 Active

 EU RoHS/ELV Code:
 5 of 6 EU RoHS/ELV Compliant

 Solder Process Capability Code:
 Not applicable for solder process capability

 China RoHS:
 for Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,						
``	183636-1	铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
O:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration of				•	nt threshold of th	
X:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration of				ove the releva	nt threshold of t	

Description for part 183636-1:

INSERT CAT5E 2x 10/100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

183641-1

(Part 1 of 1)

INSERT CAT5E 10/100BT & ISDN /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	(50) Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

SIRL-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
	183641-1	铅 (Pb)	汞 (Hg)	領 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	, Χ	0	0	0	0	0	
О:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold SJ/T 1136 3-2006 standard.			nt threshold of t				

Description for part 183641-1:

INSERT CAT5E 10/100BT & ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

183553-1

(Part 1 of 1)

INSERT Sub-D 9 pin /A

Status:
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Active 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 183553-1		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	X	0	0	0	0	0	
О:	表示该部件内有毒 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of th	
X:	Indicates that the co	§部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 tes that the concentration of the hazardous substance in the part is above the relevant threshold i136 3-2006 standard.		nt threshold of t				

Description for part 183553-1:

INSERT Sub-D 9 pin /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

183736-1

(Part 1 of 1)

INSERT 2x TEL /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 183736-1 电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		×	ο	0	о	о	0	
O:	表示该部件内有毒存 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold SJ/T 1136 3-2006 standard.				nt threshold of t			

Description for part 183736-1:

INSERT 2x TEL /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711609-1

(Part 1 of 1)

INSERT CAT7a ARJ45 style /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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58

中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance						
•	1711609-1	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold SJ/T 1136 3-2006 standard.				nt threshold of t			

Description for part 1711609-1:

INSERT CAT7a ARJ45 style /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711409-1

(Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /A

Active	Status:
5 of 6	EU RoHS/ELV Code:
Not ap	Solder Process Capability Code:
60 R	China RoHS:

5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 6(c) - Pb-Alloy in Copper 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

(50) **Restricted Materials Above Threshold** 有毒有害物质或元素 电子元件 Hazardous Substance (Electronic Component) 铅 汞 多溴联苯 1711409-1 六价铬 多溴二苯醚 镉 (Pb) (Hg) (Cd) (Cr6) (PBB) (PBDE) 电子元件 Х 0 0 0 0 0 (Electronic Component) 表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 0: Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard. X: 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711409-1:

INSERT CAT7a AMPTWIST7aS style /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336548-1

(Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /A

Status: Active EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: 50 Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 336548-1		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒体 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				oove the releva	nt threshold of t	

Description for part 336548-1:

INSERT CAT6 1x RJ45 T568A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

284584-1

(Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /A

Status:
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Active 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials	Above	Threshold
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电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,							
284584-1	铅 (Pb)	汞 (Hg)	调 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)			
(Elect	电子元件 ronic Component)	х	0	0	0	0	0		
O:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.								
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.								

Description for part 284584-1:

INSERT CAT5E 1x RJ45 T568A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336554-1

(Part 1 of 1)

INSERT CAT6 2x ISDN /A

Status:	Superseded
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

Sel-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336554-1

05 September 2012

1711807-1 INSERT CAT6a 2x ISDN /A

Active

(Equivalent Part 1 of 1)

Status: EU RoHS/ELV Code: Solder Process Capability Code:

Always EU RoHS/ELV Compliant Not applicable for solder process capability No Restricted Materials Above Threshold

Exemptions:

China RoHS:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

60

Restricted Materials Above Threshold

电子元件 (Electronic Component) 336554-1		有毒有害物质或元素 Hazardous Substance							
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
(Elect	电子元件 ronic Component)	х	0	0	0	0	0		
О:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.								
X:									

Description for part 336554-1:

INSERT CAT6 2x ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

336553-1

(Part 1 of 1)

INSERT CAT6 2x 10/100BT /A

Status: Superseded EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

sel-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336553-1

05 September 2012

1711801-1 INSERT CAT6a 2x 10/100BT /A

Active

(Equivalent Part 1 of 1)

Status:
EU RoHS/ELV Code:
Solder Process Capability Code:
China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability Or Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance:

REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

estricted Materials Above Threshold

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,						
336553-1	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
(Elect	电子元件 ronic Component)	x	0	0	0	0	0	
О:	表示该部件内有毒4 Indicates that the c SJ/T 1136 3-2006 s	oncentration of				-	nt threshold of th	
X:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration of					nt threshold of th	

Description for part 336553-1:

INSERT CAT6 2x 10/100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

5492643-1

(Part 1 of 1)

CONN KIT, I	-SC 62.5/125
Status:	Active
EU RoHS/ELV Code:	Not in Scope for EU RoHS/ELV Compliance
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	6(c) - Pb-Alloy in Copper
REACH Oct 2008 SvHC Compliance:	Contains REACH October 2008 SvHC(s)
SvHC 1:	Bis(tributyltin)oxide (CAS No: 56-35-9) @ 20.00 % wt
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Not reviewed for REACH June 2012 SvHC(s)
Halogen Content:	Not Yet Reviewed for halogen content

ORL-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

Restricted	Materials	Above	Threshold

电子元件 (Electronic Component) 5492643-1		有審有害物质或元素 Hazardous Substance							
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)		
(Elect	电子元件 ronic Component)	x	0	0	0	0	0		
О:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.								
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.								

Description for part 5492643-1:

CONN KIT, +SC 62.5/125

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



13

Statement of Compliance

Requested Part

05 September 2012

336549-1

(Part 1 of 1)

INSERT CAT6 10/100BT & ISDN /A

Status: Solder Process Capability Code: China RoHS:

Superseded EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight In homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 336549-1

05 September 2012

1711804-1 INSERT CAT6a 10/100BT & ISDN /A

Active

(Equivalent Part 1 of 1)

Status: EU RoHS/ELV Code: Solder Process Capability Code: China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability No Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 336549-1		有毒有害物质或元素 ————————————————————————————————————							
	铅 (Pb)	汞 (Hg)	領 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)			
电子元件 (Electronic Component)		х	0	0	0	0	0		
0:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t		
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.								

Description for part 336549-1:

INSERT CAT6 10/100BT & ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711188-1

(Part 1 of 1)

INSERT 1x RJ45 10 GBE /A

Status:	
EU RoHS/ELV Code:	
Solder Process Capability Code:	
China RoHS:	and the second

Superseded 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

sel-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



RoHS Equivalent Part(s) for Part 1711188-1

05 September 2012

1711796-1 INSERT CAT6a 1x RJ45 T568A /A

Active

(Equivalent Part 1 of 1)

Status: EU RoHS/ELV Code: Solder Process Capability Code: China RoHS:

Always EU RoHS/ELV Compliant Not applicable for solder process capability

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: Description of Difference: No Substance>Threshold Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content New AMP CO Cat6A Inserts

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711188-1		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
O:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of t	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				ove the releva	nt threshold of t	

Description for part 1711188-1:

INSERT 1x RJ45 10 GBE /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711609-5

(Part 1 of 1)

INSERT CAT7a ARJ45 style /W

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	60 Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

Spel-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711609-5		有 串 有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
О:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of t	
X:	表示该部件内有毒有 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o	• -			oove the releva	nt threshold of I	

Description for part 1711609-5:

INSERT CAT7a ARJ45 style /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711609-3

(Part 1 of 1)

INSERT CAT7a ARJ45 style /B

 Status:
 Active

 EU RoHS/ELV Code:
 5 of 6 EU RoHS/ELV Compliant

 Solder Process Capability Code:
 Not applicable for solder process capability

 China RoHS:
 Image: China RoHS (Compliant RoHS)

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711609-3 电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		х	0	Ο	0	0	0	
О:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o					nt threshold of th	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.							

Description for part 1711609-3:

INSERT CAT7a ARJ45 style /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711409-5

(Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /W

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Evenationer	C(a) Dh Allavia Connor

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 6(c) - Pb-Alloy in Copper 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

(50)	

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711409-5		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	Х	0	0	0	0	0	
O:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.							
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of SJ/T 1136 3-2006 standard.							

Description for part 1711409-5:

INSERT CAT7a AMPTWIST7aS style /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711409-3

(Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /B

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
	Not applicable for solder process capability
China RoHS:	60 Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 6(c) - Pb-Alloy in Copper 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

(50)

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711409-3		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
	电子元件 onic Component)	х	0	0	0	0	0	
О:	表示该部件内有毒有 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X:	表示该部件内有毒有 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of th	

Description for part 1711409-3:

INSERT CAT7a AMPTWIST7aS style /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711336-1

(Part 1 of 1)

INSERT MULTIMEDIA CATV&TEL&100BT /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 6(c) - Pb-Alloy in Copper 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,						
•	1711336-1	铅 (Pb)	汞 (Hg)	領 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
О:	表示该部件内有毒体 Indicates that the ca SJ/T 1136 3-2006 s	oncentration of				•	nt threshold of t	
X:	表示该部件内有毒本 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of t	

Description for part 1711336-1:

INSERT MULTIMEDIA CATV&TEL&100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711336-3

(Part 1 of 1)

INSERT MULTIMEDIA CATV&TEL&100BT /B

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	6(c) - Pb-Alloy in Copper
	7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711336-3		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	領 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	x	0	0	0	0	0	
0:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o		•• • • • • •		-	nt threshold of t	
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				oove the releva	nt threshold of t	

Description for part 1711336-3:

INSERT MULTIMEDIA CATV&TEL&100BT /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711130-5

(Part 1 of 1)

Status: Active EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(a) - Pb-High melt temp. solder 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
	1711130-5	铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	x	0	0	0	0	0	
О:	表示该部件内有毒存 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of t	
X:	表示该部件内有毒本 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o					nt threshold of	

Description for part 1711130-5:

INSERT ISDN & PoE B->A for PP /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711130-1

(Part 1 of 1)

PoE B->A for PP /A
Active
5 of 6 EU RoHS/ELV Compliant
Not applicable for solder process capability
Restricted Materials Above Threshold
7(a) - Pb-High melt temp. solder
7(x) - Pb-Used for ELV, 5/6 parts
Not reviewed for REACH October 2008 SvHC(s)
Not reviewed for REACH Jan/Mar 2010 SvHC(s)
Contains no REACH June 2010 SvHC(s)
Contains no REACH December 2010 SvHC(s)
Not reviewed for REACH June 2011 SvHC(s)
Not reviewed for REACH December 2011 SvHC(s)
Not reviewed for REACH June 2012 SvHC(s)
Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711130-1 电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance,						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		х	0	0	0	0	0	
О:	表示该部件内有毒 Indicates that the ca SJ/T 1136 3-2006 s	oncentration o				-	nt threshold of th	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.							

Description for part 1711130-1:

INSERT ISDN & PoE B->A for PP /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711130-3

(Part 1 of 1)

INSERT ISDN & PoE B->A for PP /B

INOLINI IODIN & F	
Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	7(a) - Pb-High melt temp. solder
	7(x) - Pb-Used for ELV, 5/6 parts
REACH Oct 2008 SvHC Compliance:	Not reviewed for REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

ORL.

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

60)

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711130-3		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镐 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多澳二苯醚 (PBDE)	
(Elect	电子元件 rronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration o					nt threshold of t	

Description for part 1711130-3:

INSERT ISDN & PoE B->A for PP /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, P8B, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711140-1

(Part 1 of 1)

INSERT ISDN & PoE mode A /A

Status: Active

China RoHS:

Solder Process Capability Code:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability (50) Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

50

Restricted Materials Above Threshold

(Elect	电子元件 ronic Component)	有毒有害物质或元素 Hazardous Substance,						
	1711140-1	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	Х	0	0	0	0	0	
О:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X:	表示该部件内有毒体 Indicates that the c SJ/T 1136 3-2006 s	oncentration o	••••			oove the releva	nt threshold of t	

Description for part 1711140-1:

INSERT ISDN & PoE mode A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711140-3

(Part 1 of 1)

INSERT ISDN & PoE mode A /B Status: Active

Solder Process Capability Code: China RoHS:

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

E Del

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

(30)

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711140-3		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration o					nt threshold of t	

Description for part 1711140-3:

INSERT ISDN & PoE mode A /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711336-5

(Part 1 of 1)

INSERT MULTIMEDIA CATV&TEL&100BT /W

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	6(c) - Pb-Alloy in Copper
	7(x) - Pb-Used for ELV, 5/6 parts
REACH Oct 2008 SvHC Compliance:	Not reviewed for REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Not reviewed for REACH June 2012 SvHC(s)
Halogen Content:	Not Yet Reviewed for halogen content

ORL-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

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Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711336-5		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	Q	0	0	0	0	
0:	表示该部件内有毒4 Indicates that the c SJ/T 1136 3-2006 s	oncentration of					nt threshold of th	
X:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration of					nt threshold of t	

Description for part 1711336-5:

INSERT MULTIMEDIA CATV&TEL&100BT /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711125-5

(Part 1 of 1)

INSERT dual Pol	E B->A for PP /W
Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	7(a) - Pb-High melt temp. solder
	7(x) - Pb-Used for ELV, 5/6 parts
REACH Oct 2008 SvHC Compliance:	Not reviewed for REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Not reviewed for REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH Dec 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Not reviewed for REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Not reviewed for REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Not reviewed for REACH June 2012 SvHC(s)
Halogen Content:	Not Yet Reviewed for halogen content

SPEL

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

Restricted Material	s Above Three	shold			stance 介铬
电子元件 (Electronic Component)				客物质或元素 bus.Substance	
 1711125-5	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	
电子元件	x	0	0	0	Γ

O: 表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard. X: 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the

多溴联苯

(PBB)

0

多溴二苯醚

(PBDE)

0

Description for part 1711125-5:

SJ/T 1136 3-2006 standard.

(Electronic Component)

INSERT dual PoE B->A for PP /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711125-1

(Part 1 of 1)

INSERT d	lual PoE B->	A for PP /A
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Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(a) - Pb-High melt temp. solder 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

SPEL-

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711125-1		有毒有害物质或元素 Hazardous Substance,						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
0:	表示该部件内有毒和 Indicates that the c SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th	
X: 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of SJ/T 1136 3-2006 standard.								

Description for part 1711125-1:

INSERT dual PoE B->A for PP /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711125-3

(Part 1 of 1)

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(a) - Pb-High melt temp. solder 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) - 1711125-3		有舉有害物质或元素 ————————————————————————————————————					
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
	电子元件	х	0	0	0	0	0
(Electro	onic Component)						
O:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	ncentration o				-	nt threshold of t
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	ncentration o					nt threshold of t

Description for part 1711125-3:

INSERT dual PoE B->A for PP /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711000-5

(Part 1 of 1)

INSERT 4x RJ45 TEL /W

Active	Status:
5 of 6 E	EU RoHS/ELV Code:
Not app	Solder Process Capability Code:
	China RoHS:

Active 5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

E Del

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711000-5		有毒有害物质或元素 Hazardous Substance,						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	Х	0	0	0	0	0	
О:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.							
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.							

Description for part 1711000-5:

INSERT 4x RJ45 TEL /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711000-1

(Part 1 of 1)

INSERT 4x RJ45 TEL /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711000-1		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	录 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
(Elect	电子元件 ronic Component)	х	0	0	0	0	0	
O:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of t	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.							

Description for part 1711000-1:

INSERT 4x RJ45 TEL /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711000-3

(Part 1 of 1)

INSERT 4x RJ45 TEL /B

Active	Status:
5 of 6 EU Ro	EU RoHS/ELV Code:
Not applicable	Solder Process Capability Code:
(50) Restrict	China RoHS:

5 of 6 EU RoHS/ELV Compliant Not applicable for solder process capability Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

Del_

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

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Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711000-3 电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance、						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		×	0	ο	0	0	0	
O:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.							
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of th SJ/T 1136 3-2006 standard.							

Description for part 1711000-3:

INSERT 4x RJ45 TEL /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



Requested Part

05 September 2012

1711001-5

(Part 1 of 1)

INSERT 4x RJ45 TEL 100ohm term /W				
Status:	Active			
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant			
Solder Process Capability Code:	Not applicable for solder process capability			
China RoHS:	Restricted Materials Above Threshold			
Exemptions:	7(x) - Pb-Used for ELV, 5/6 parts			

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711001-5		有毒有害物质或元素 ————————————————————————————————————					
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
(Elect	电子元件 ronic Component)	x	0	0	0	0	0
0:	表示该部件内有毒 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of t
X:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o					nt threshold of t

Description for part 1711001-5:

INSERT 4x RJ45 TEL 100ohm term /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711001-1

(Part 1 of 1)

INSERT 4x RJ45 T	EL 100ohm term /A
Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711001-1 电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		×	ο	ο	0	0	0	
O:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of th SJ/T 1136 3-2006 standard.							
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of SJ/T 1136 3-2006 standard.							

Description for part 1711001-1:

INSERT 4x RJ45 TEL 100ohm term /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711001-3

(Part 1 of 1)

INSERT 4x RJ45 T	EL 100ohm term /B
Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold
Exemptions:	7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: No REACH Jan/Mar 2010 SvHC Compliance: No REACH June 2010 SvHC Compliance: Co REACH Dec 2010 SvHC Compliance: No REACH June 2011 SvHC Compliance: No REACH December 2011 SvHC Compliance: No REACH June 2012 SvHC Compliance: No Halogen Content: No

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not reviewed for REACH June 2012 SvHC(s)

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息

China EIP Environmental Information

Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711001-3 电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		х	0	0	0	0	0	
0:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of th SJ/T 1136 3-2006 standard.							
X:	SJ/1 1136 3-2006 standard. 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.							

Description for part 1711001-3:

INSERT 4x RJ45 TEL 100ohm term /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711100-5

(Part 1 of 1)

INSERT 10/100BT & 2x TEL /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant Solder Process Capability Code: Not applicable for solder process capability China RoHS: Restricted Materials Above Threshold

Exemptions: REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).



中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711100-5 电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————					
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
		x	0	0	О	о	0
О:	表示该部件内有毒有 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				•	nt threshold of th
X:	SJ/T 1136 3-2006 standard. 表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of SJ/T 1136 3-2006 standard.						nt threshold of t

Description for part 1711100-5:

INSERT 10/100BT & 2x TEL /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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Requested Part

05 September 2012

1711100-1

(Part 1 of 1)

INSERT 10/100BT & 2x TEL /A

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
Solder Process Capability Code:	Not applicable for solder process
China RoHS:	Restricted Materials Above

er process capability Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content:

7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender **Director, Product Compliance**

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

123

中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711100-1 电子元件 (Electronic Component)		有毒有害物质或元素 Hazardous Substance						
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
		х	0	O	0	0	0	
О:	表示该部件内有毒存 Indicates that the co SJ/T 1136 3-2006 s	oncentration o				•	it threshold of t	
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of SJ/T 1136 3-2006 standard.						nt threshold of t	

Description for part 1711100-1:

INSERT 10/100BT & 2x TEL /A

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Requested Part

05 September 2012

1711100-3

(Part 1 of 1)

INSERT 10/100BT & 2x TEL /B

Status:	Active
EU RoHS/ELV Code:	5 of 6 EU RoHS/ELV Compliant
	Not applicable for solder process capability
China RoHS:	Restricted Materials Above Threshold

Exemptions:

REACH Oct 2008 SvHC Compliance: REACH Jan/Mar 2010 SvHC Compliance: REACH June 2010 SvHC Compliance: REACH Dec 2010 SvHC Compliance: REACH June 2011 SvHC Compliance: REACH December 2011 SvHC Compliance: REACH June 2012 SvHC Compliance: Halogen Content: 7(x) - Pb-Used for ELV, 5/6 parts Not reviewed for REACH October 2008 SvHC(s) Not reviewed for REACH Jan/Mar 2010 SvHC(s) Contains no REACH June 2010 SvHC(s) Contains no REACH December 2010 SvHC(s) Not reviewed for REACH June 2011 SvHC(s) Not reviewed for REACH December 2011 SvHC(s) Not reviewed for REACH June 2012 SvHC(s) Not Yet Reviewed for halogen content

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David R. Bender Director, Product Compliance

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中国电子信息产品环境信息

China EIP Environmental Information

电子元件 (Electronic Component) 1711100-3 电子元件 (Electronic Component)		有毒有害物质或元素 ————————————————————————————————————					
		铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
		x	0	Ο	0	0	0
О:	表示该部件内有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.						
X:	表示该部件内有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of t SJ/T 1136 3-2006 standard.						

Description for part 1711100-3:

INSERT 10/100BT & 2x TEL /B

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